



POM copolymer, modified Injection molding type, elastomer-containing; with higher impact strength and slightly lower hardness, rigidity and chemical resistance than unmodified acetal copolymer. Reduced emission grade, Emission according to VDA 275 < 5 mg/kg good weld strength. Burning rate according to FMVSS 302 < 100 mm/min (1 mm thickness).

ECO-C: Hostaform® POM S 9243 XAP®2 ECO-C 772 incorporates circular content derived from captured carbon dioxide emissions in the finished product through mass balance allocation. The product is a drop-in replacement to the standard grade with the same performance and processing properties and contributes to the displacement of virgin fossil fuel resources. The feedstock utilizing captured carbon dioxide emissions are ISCC CFC certified as low carbon intensity methanol.

Product information

Product information			
Resin Identification	POM-I		ISO 1043
Part Marking Code	>POM-I<		ISO 11469
Rheological properties			
Melt volume-flow rate		cm ³ /10min	ISO 1133
Temperature	190		
Load	2.16		
Moulding shrinkage, parallel	1.9		ISO 294-4, 2577
Moulding shrinkage, normal	1.8	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus	1950	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min		MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min			ISO 527-1/-2
Nominal strain at break	40		ISO 527-1/-2
Flexural modulus	1850		ISO 178
Tensile creep modulus, 1h	1700		ISO 899-1
Tensile creep modulus, 1000h		MPa kJ/m²	ISO 899-1 ISO 179/1eU
Charpy impact strength, 23°C Charpy impact strength, -30°C		kJ/m ²	ISO 179/1eU
Charpy notched impact strength, 23°C		kJ/m ²	ISO 179/1eA
Charpy notched impact strength, -30°C		kJ/m ²	ISO 179/1eA
Poisson's ratio	0.45		.55 7.57
[P]: Partial Break			
Thermal properties			
Melting temperature, 10°C/min	166	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa		°C	ISO 75-1/-2
Coefficient of linear thermal expansion	120	E-6/K	ISO 11359-1/-2
(CLTE), parallel			
Electrical properties			
Relative permittivity, 100Hz	3.8		IEC 62631-2-1
Relative permittivity, 1MHz	3.8		IEC 62631-2-1
Dissipation factor, 100Hz		E-4	IEC 62631-2-1
Dissipation factor, 1MHz		E-4	IEC 62631-2-1
Volume resistivity	1E11	Ohm.m	IEC 62631-3-1

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Surface resistivity	1E13 Ohm	IEC 62631-3-2
Comparative tracking index	600	IEC 60112

Physical/Other properties

Humidity absorption, 2mm	0.2 %	Sim. to ISO 62
Water absorption, 2mm	1 %	Sim. to ISO 62
Density	1330 kg/m ³	ISO 1183

Injection

Drying Recommended	no	
Drying Temperature	100	°C
Drying Time, Dehumidified Dryer	3 - 4	h
Processing Moisture Content	≤0.2	%
Melt Temperature Optimum	195	°C
Min. melt temperature	190	°C
Max. melt temperature	200	°C
Screw tangential speed	≤0.3	m/s
Mold Temperature Optimum	70	°C
Min. mould temperature	60	°C
Max. mould temperature	80	°C
Hold pressure range	60 - 120	MPa
Back pressure	2	MPa

Characteristics

Processing Injection Moulding

Delivery form Pellets

Additives Release agent

Special characteristics High impact or impact modified, Low emissions, Improved weld line

Sustainability Carbon Capture

Additional information

Processing Notes Pre-Drying

It is normally not necessary to dry HOSTAFORM. However, should there be surface moisture (condensate) on the molding compound as a result of incorrect storage, drying is required. A circulating air drying cabinet can be used for this purpose if the granul

Storage

The product can then be stored in standard conditions until processed.

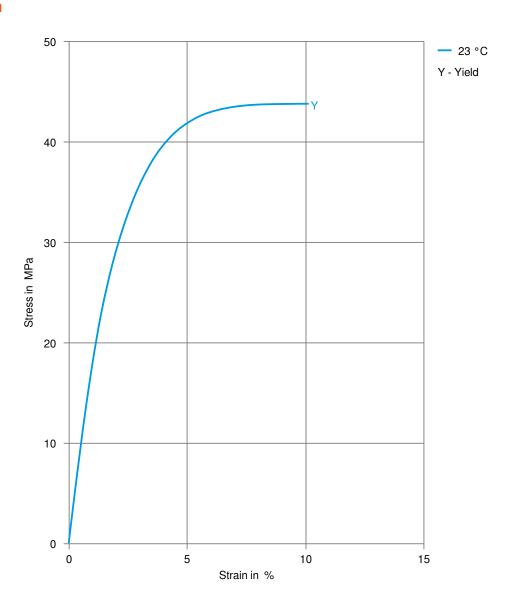
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Stress-strain

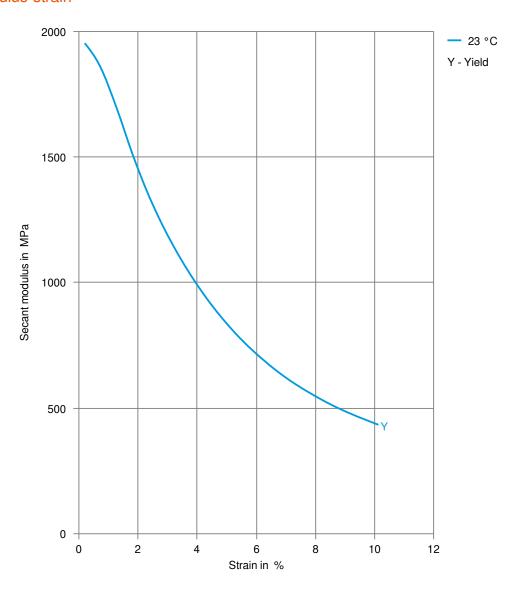


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Secant modulus-strain



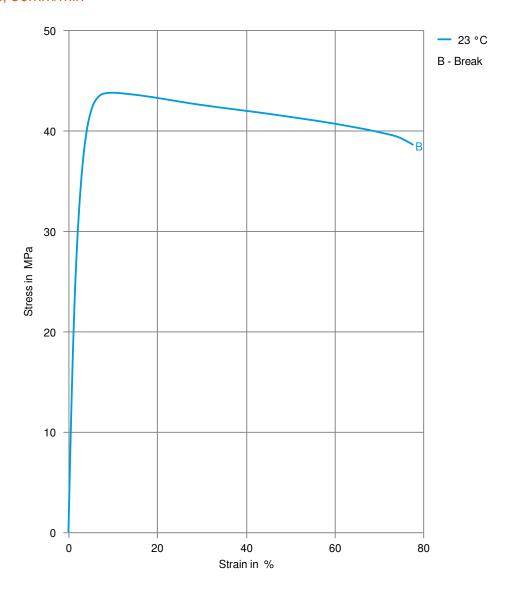
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Stress-strain, 50mm/min

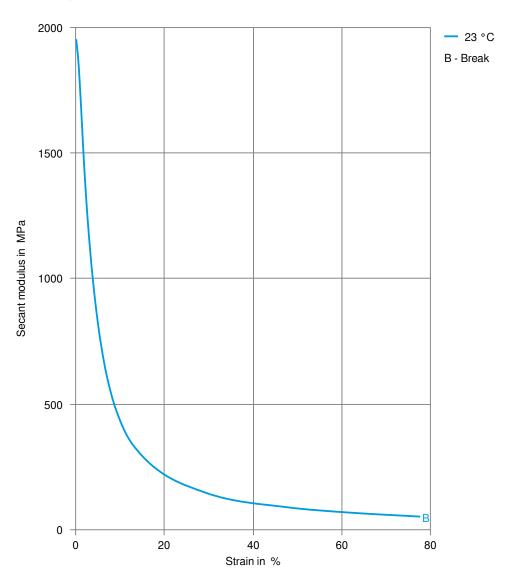


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Secant modulus-strain, 50mm/min



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